

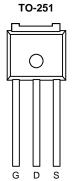
# SFT1450-VB TO251 Datasheet N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)		
40	$0.0F3 \text{ at V}_{GS} = 10 \text{ V}$	55 <sup>d</sup>	F9.5		
40	0.0FI at $V_{GS} = 4.5 \text{ V}$	I 5 <sup>d</sup>	19.5		

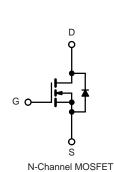
#### **FEATURES**

- · Halogen-free According to IEC 61249-2-21 Definition
- VBmos® Trench Cell
- 100 % R<sub>g</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





Top View



#### **APPLICATIONS**

- · Power Supply
  - Secondary Synchronous Rectification
- DC/DC Converter

ABSOLUTE MAXIMUM RATINGS	$T_C = 25  ^{\circ}C$ , unless oth	erwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	40	V		
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C	L	55 <sup>d</sup>		
	T <sub>C</sub> = 70 °C	I <sub>D</sub>	I 5 <sup>d</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	165		
Avalanche Current		I <sub>AS</sub>	H4		
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	Ϊ8	mJ	
Mariana Danas Diada di adi	T <sub>C</sub> = 25 °C	D	Í 5.5 <sup>b</sup>	10/	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C <sup>c</sup>	P <sub>D</sub>	2.7	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) <sup>c</sup>	R <sub>thJA</sub>	ĺ4	°C/W
Junction-to-Case (Drain)	R <sub>thJC</sub>	2.Ï	- C/W

#### Notes:

- a. Duty cycle  $\leq$  1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>DS</sub> = 0 V, I <sub>D</sub> = 250 μA	40			\ /
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		2.5	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 250	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0 V			1	
	I <sub>DSS</sub>	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μA
		V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C			250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	55			Α
	Б	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A		0.0F3		Ω
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A		0.0FI		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		1€0		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			1100		
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 15 V, f = 1 MHz		460		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			350		
Total Gate Charge <sup>c</sup>		V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		H6		
Total Gate Gharge	Qg			25		200
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		Î		nC
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			Í .7		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	2	4	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			8	16	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, R_{L} = 1.5 \Omega$		9	18	no
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53	ns
Fall Time <sup>c</sup>	t <sub>f</sub>			9	18	
Drain-Source Body Diode Ratings a	nd Characteris	stics T <sub>C</sub> = 25 °C <sup>b</sup>				
Continuous Current	I <sub>S</sub>				55	۸
Pulsed Current	I <sub>SM</sub>				165	Α
Forward Voltage <sup>a</sup>	$V_{SD}$	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V		0.75	1.5	V
Reverse Recovery Time	t <sub>rr</sub>			34	51	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs		2	3	Α
Reverse Recovery Charge	Q <sub>rr</sub>			34	51	nC

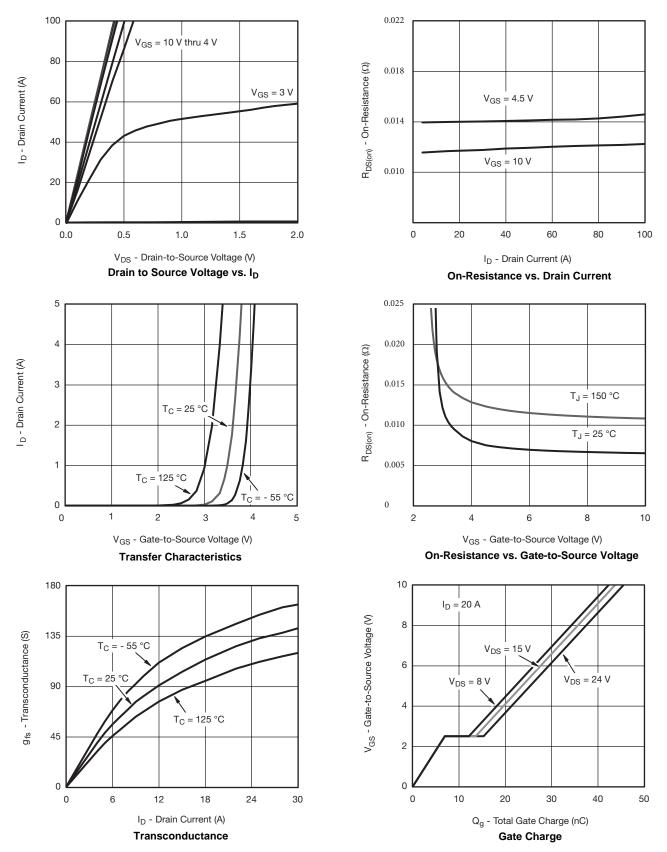
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

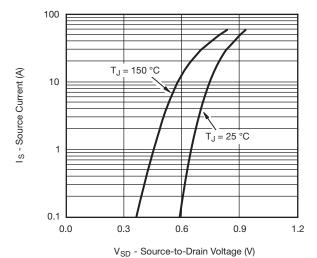


#### TYPICAL CHARACTERISTICS 25 C, unless otherwise noted

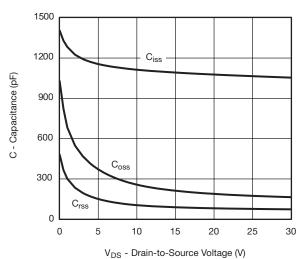




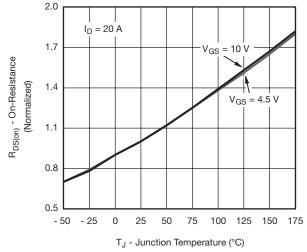
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



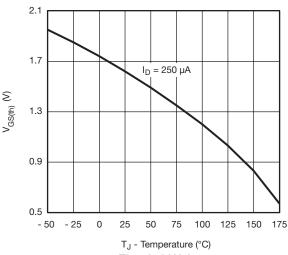
Source-Drain Diode Forward Voltage



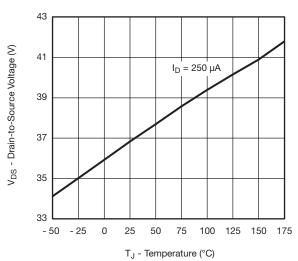
Capacitance



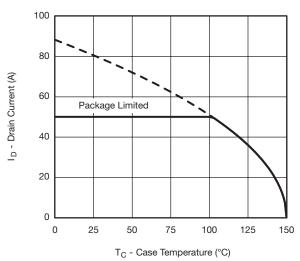
On-Resistance vs. Junction Temperature



Threshold Voltage



**Drain Source Breakdown vs. Junction Temperature** 

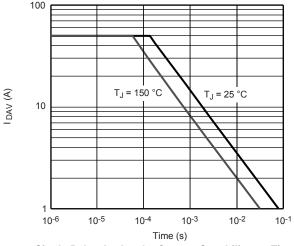


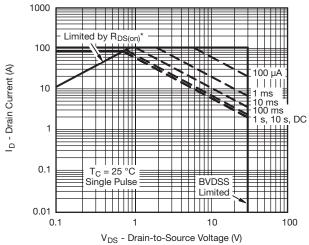
**Current Derating** 

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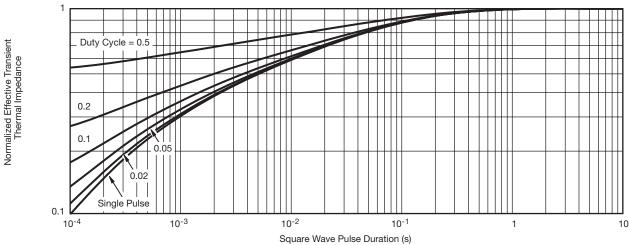
### TYPICAL CHARACTERISTICS 25 C, unless otherwise noted





Single Pulse Avalanche Current Capability vs. Time

 $^{\star}$   $V_{GS}>$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified Safe Operating Area

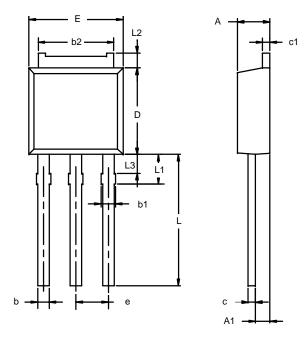


Normalized Thermal Transient Impedance, Junction-to-Case



### **TO-251AA**

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Note: Dimension L3 is for reference only.

Min 2.21 0.89 0.71 0.76	2.38 1.14 0.89	Min 0.087 0.035	0.094 0.045
0.89	1.14		
0.71		0.035	0.045
	0.89		0.043
0.76		0.028	0.035
0.70	1.14	0.030	0.045
5.23	5.43	0.206	0.214
0.46	0.58	0.018	0.023
0.46	0.58	0.018	0.023
5.97	6.22	0.235	0.245
6.48	6.73	0.255	0.265
2.28	BSC	0.090	BSC
3.89	9.53	0.153	0.375
1.91	2.28	0.075	0.090
0.89	1.27	0.035	0.050
1.15	1.52	0.045	0.060
	0.46 0.46 5.97 6.48 2.28 3.89 1.91 0.89 1.15	0.46	0.46 0.58 0.018   0.46 0.58 0.018   5.97 6.22 0.235   6.48 6.73 0.255   2.28 BSC 0.090   3.89 9.53 0.153   1.91 2.28 0.075   0.89 1.27 0.035   1.15 1.52 0.045   46—Rev. E, 09-Jul-01

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